

Product Change Notification - GBNG-18NQCZ306

Date:

22 Jul 2019

Product Category:

Temperature Sensors

Affected CPNs:



Notification subject:

CCB 3875 Final Notice: Implement new Tape and Reel packing media for selected Atmel products of the 35.4k wafer technology available in 8L UDFN (2x3x0.6mm) and WDFN (2x3x0.8mm) packages at MTAI assembly site.

Notification text:

PCN Status:

Final notification

PCN Type:

Manufacturing Change

Microchip Parts Affected:

Please open one of the icons found in the Affected CPNs section above.

NOTE: For your convenience Microchip includes identical files in two formats (.pdf and .xls).

Description of Change:

Implement new Tape and Reel packing media for selected Atmel products of the 35.4k wafer technology available in 8L UDFN (2x3x0.6mm) and WDFN (2x3x0.8mm) packages at MTAI assembly site.

Pre Change:

Using carrier tape with 8mm width, cover tape with 5.3mm width and white plastic reel.

Post Change:

Using carrier tape with 8mm width, cover tape with 5.4mm width and dark blue plastic reel.

Pre and Post Change Summary:

| Fre and Fost Change Summary. | | | | | | | | |
|------------------------------|----------------------|-----------------|--------------|--|--|--|--|--|
| lte | em | Pre Change | Post Change | | | | | |
| | Width | 8 +0.3 | 8 +0.3/-0.1 | | | | | |
| Carrier Tape | A0 | 2.30 ±0.1 | 2.25 ±0.1 | | | | | |
| Carrier rape | B0 | 3.20 ±0.1 | 3.35 ±0.1 | | | | | |
| | K0 | 1.00 +0.1/-0.05 | 1.05 ±0.1 | | | | | |
| | Width | 5.3 ±0.1 | 5.4 ±0.1 | | | | | |
| Cover Tape | Thickness | 0.056 | 0.062 | | | | | |
| | THICKITESS | ±0.005 | ±0.013 | | | | | |
| | (A) Reel Diameter | 330 +/- 2.0 | 330 +/- 2.0 | | | | | |
| | (N) Hub Diameter | 100 ± 2.0 | 178 +0/- 2.0 | | | | | |
| | (W1) Reel Thickness | 8.4 +2.0/-0 | 8.4 +2.0/-0 | | | | | |
| Plastic Reel | (W2) Total Thickness | 14.4 | 14.4 | | | | | |
| | (C) Center Hole | 13 +0.5/-0.2 | 13 +0.5/-0.2 | | | | | |
| | Diameter | | | | | | | |
| | Color | White | Dark Blue | | | | | |
| Pin 1 Orientation | | Quadrant 2 | Quadrant 2 | | | | | |

Note: 1) All dimensions are in millimeters (mm)

2) Please review the attached document for pre and post details of the changes.

Impacts to Data Sheet:

None

Change Impact:

None



Reason for Change:

To improve manufacturability by implementing new Tape and Reel packing media.

Change Implementation Status:

In Progress

Estimated First Ship Date:

August 22, 2019 (date code: 1934)

NOTE: Please be advised that after the estimated first ship date customers may receive pre and

post change parts.

Time Table Summary:

| | July 2019 | | | | | August 2019 | | | | |
|-------------------------------|-----------|----|----|----|----|-------------|----|----|----|--|
| Workweek | 27 | 28 | 29 | 30 | 31 | 32 | 33 | 34 | 35 | |
| Final PCN Issue Date | | | | Χ | | | | | | |
| Qual Report Availability | | | | Χ | | | | | | |
| Estimated Implementation Date | | | | | | | | Χ | | |

Method to Identify Change:

Traceability code

Qualification Report:

Please open the attachments included with this PCN labeled as PCN_#_Qual Report.

Revision History:

July 22, 2019: Issued final notification. Attached the qualification report. Provided the estimated first ship date to be on August 22, 2019.

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable products.

Attachment(s):

PCN GBNG-18NQCZ306 Qual Report and Pre and Post Change.pdf

Please contact your local <u>Microchip sales office</u> with questions or concerns regarding this notification.

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If you wish to <u>change your PCN profile</u>, <u>including opt out</u>, please go to the <u>PCN home page</u> select login and sign into your myMicrochip account. Select a profile option from the left navigation bar and make the applicable selections.





PCN #: GBNG-18NQCZ306

Implement new Tape and Reel packing media for selected Atmel products of the 35.4k wafer technology available in 8L UDFN (2x3x0.6mm) and WDFN (2x3x0.8mm) packages at MTAI assembly site.

CCB 3875



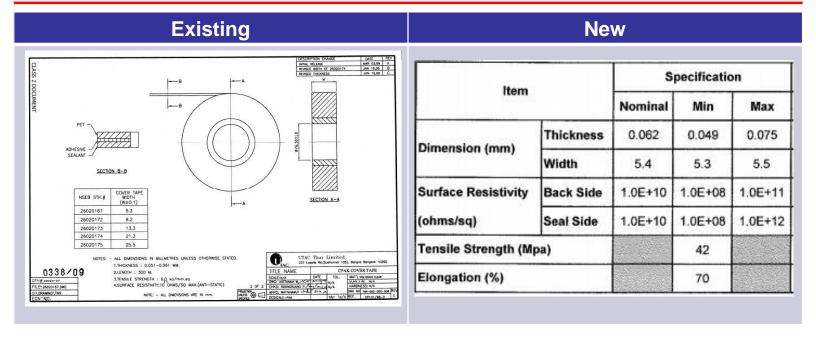
Carrier Tape Pre and Post Change

PRE CHANGE OVER 1 SOURCES | STATE | SOURCES | SOURCES | STATE | SOURCES | STATE | SOURCES | STATE | SOURCES | SOURCES | SOURCES | STATE | SOURCES | SOURCES | STATE | SOURCES | STATE | SOURCES | STATE | SOURCES | SOURCES | SOURCES | STATE | SOURCES | SOURCES | STATE | SOURCES | SOURCES

| Location | Width (mm) | Pitch (mm) | A0 (mm) | B0 (mm) | K0 (mm) |
|-------------|---------------------|---------------|------------|------------|-----------------|
| Pre Change | 8 +0.3 | 4 ±0.1 | 2.30 ±0.1 | 3.20 ±0.1 | 1.00 +0.1/-0.05 |
| Post Change | 8 +0.3 /-0.1 | 4 ±0.1 | 2.25 ±0.1 | 3.35 ±0.1 | 1.05 ±0.1 |



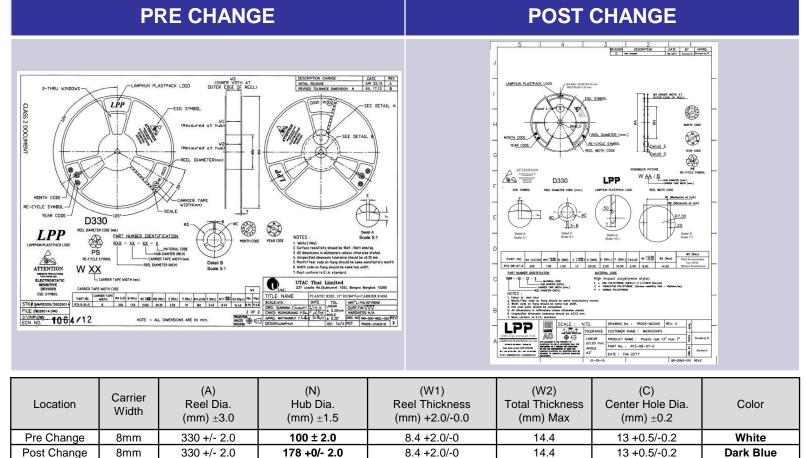
Cover Tape Pre and Post Change



| Location | Width (mm) or Specific | Thickness (mm) |
|-------------|------------------------|----------------|
| Pre Change | 5.3 ±0.1 | 0.056 ±0.005 |
| Post Change | 5.4 ±0.1 | 0.062 ±0.013 |

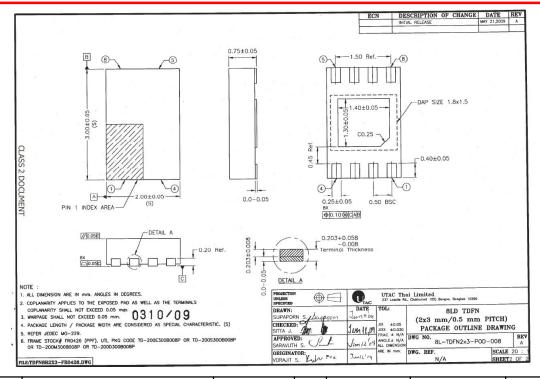


Plastic Reel Pre and Post Change





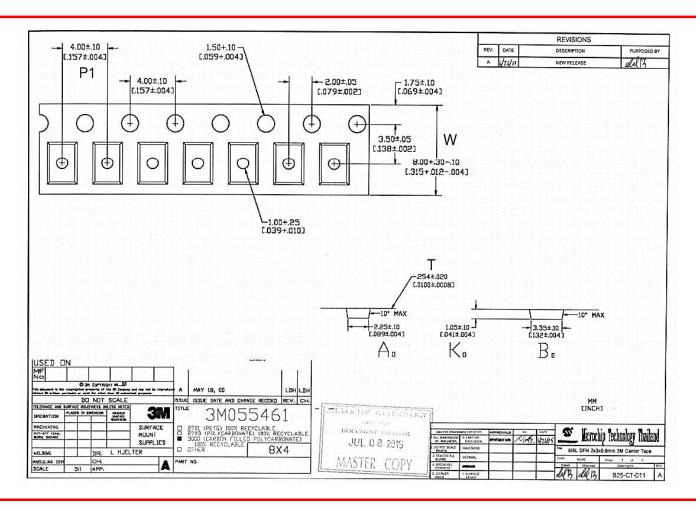
Packing Specs New Material Package Outline Dimension



| Pkg Code | Package Code Description (50 character maximum) | Package Type (8 Char Max.) | Lead Count | Industry Standard | Package Width Or Size ³ NO SPACES | Microchip Assigned Pkg Otln Dwg No. |
|----------|--|-------------------------------|------------|-------------------|---|---|
| QEB | Very Thin Quad Flatpack No-Leads | WDFN | 008 | JEDEC | 2x3x0.8mm | C04-21364 |
| QFB | Very Thin Quad Flatpack No-Leads | WDFN | 008 | JEDEC | 2x3x0.8mm | C04-21365 |



Packing Specs New Carrier Tape





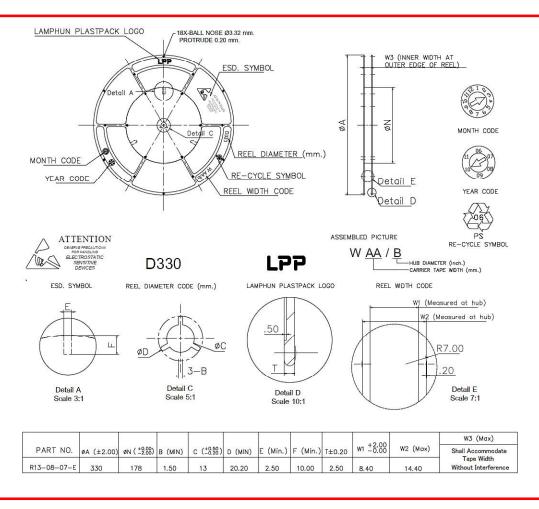
Packing Specs New Cover Tape

| Description | 144-9440111-2-11 | Units | Typical performance | Test | Test method |
|-----------------------|---|--|---|-----------------------|---|
| Material properties | Backing type Adhesive type Sealing temp | °C | Polyester Heat activated 170~220 | 1 | |
| Physical properties | Tensile strength Elongation Haze Clarity Transmission Thickness | Mpa % % % mm (in) | 50 100 29.5 80.6 85.5 0.062 (0.0024) | 2 2 3 3 3 | Modified ASTM-D3759 Modified ASTM-D3759 ASTM-D1003 ASTM-D1003 ASTM-D1003 Modified ASTM-D3652 |
| Electrical properties | Resistivity (Back side) Resistivity (Component side) | Ohms/sq Ohms/sq | 10 ⁹ | 4 | ASTM-D257 ASTM-D257 |
| Product format | Core type Core inner diameter Roll diameter Roll length | Material mm (in) mm (in) m (yd) | Plastic 76.45 (3.0) 219 (8.62) 480 (525) | | |

| Item | | Specification | | | | | | |
|---------------------|-----------|---------------|---------|---------|--|--|--|--|
| item | | Nominal | Min | Max | | | | |
| Dimonolon (mm) | Thickness | 0.062 | 0.049 | 0.075 | | | | |
| Dimension (mm) | Width | 5.4 | 5.3 | 5.5 | | | | |
| Surface Resistivity | Back Side | 1.0E+10 | 1.0E+08 | 1.0E+11 | | | | |
| (ohms/sq) Seal Side | | 1.0E+10 | 1.0E+08 | 1.0E+12 | | | | |
| Tensile Strength (M | | 42 | | | | | | |
| Elongation (%) | | 70 | | | | | | |

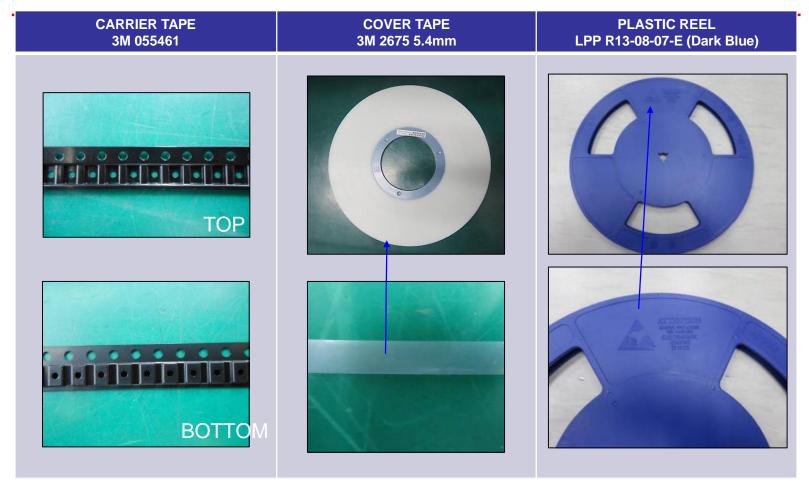


Packing Specs New Plastic Reel



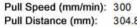


Qualification Results Packing Material (NEW)





Qualification Results New Carrier Tape Peel Strength Test

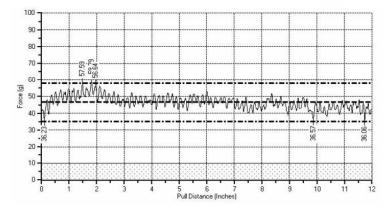


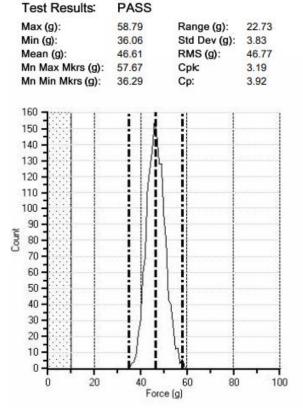
Carrier Tape: 3M/155049-1/22008403 Cover Tape: 3M/18349 W2HM/22100306

Front Shoe Rear Shoe

Temperature (C): 180 180 Pressure: 2 2 Width: 0 0

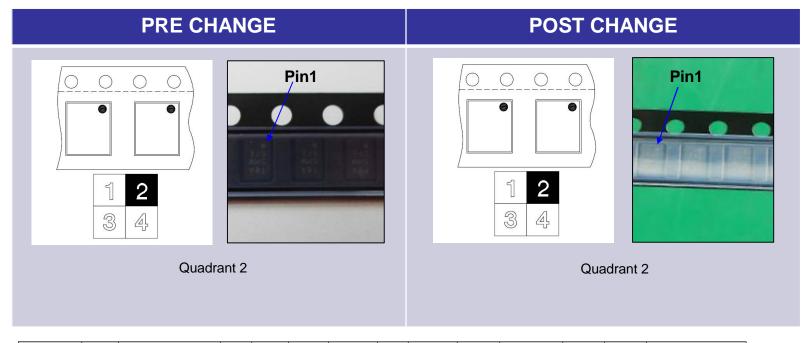
Analysis Criteria Setting Result 100 PASS Upper Alarm Lmt (g): Lower Alarm Lmt (g): 10 PASS Upper Mean Lmt (g): 60 **PASS** Lower Mean Lmt (g): 45 **PASS** PASS Cpk >: 1.67







Qualification Results Packing Specification



| Package Type | Lead Count | Package Width | MSL | Pb-Free | Dry Pack | Desiccant per Bag | Tape Width (mm) | Pocket Pitch (mm) | Reel Dia. (mm) | Reel HUB size (mm) Proposal | Units per Reel | Units per Box | Component Orientation Quadrant |
|--------------|---------------|---------------|-----|---------|----------|----------------------|-----------------------|----------------------|-------------------|-----------------------------------|-------------------|------------------|-----------------------------------|
| WDFN | 8 | 2x3x0.8mm | 1 | 260 | N | 0 | 8 | 4 | 330 | 178 | 5000 | 5000 | 2 |
| WDFN | 8 | 2x3x0.8mm | 1 | 260 | N | 0 | 8 | 4 | 330 | 178 | 5000 | 5000 | 2 |

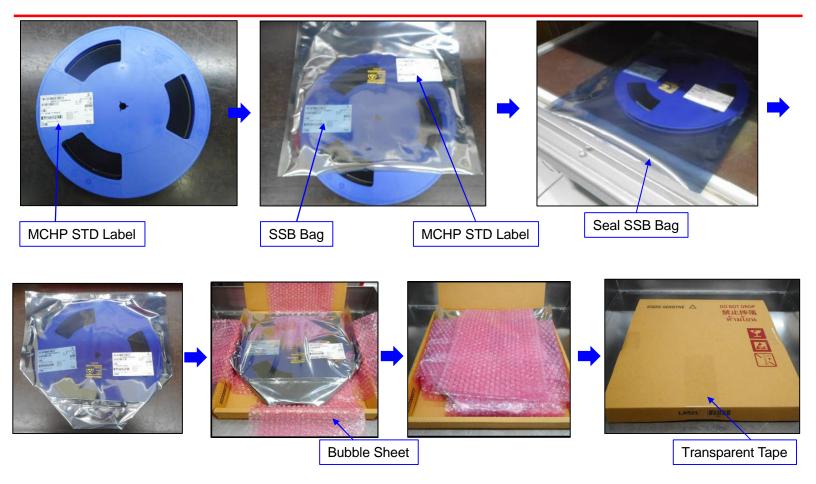


Qualification Results New Carrier Tape Testing Result

| Bent Testing | Swing Testing | RIP Testing |
|--------------------|--------------------|---------------------------|
| | | |
| | | |
| Not Found Seal off | Not Found Seal off | Not found Cover Tape torn |



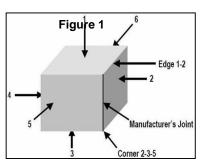
Qualification Results New Packing Method





New Material Drop Test Result





Drop Test Method:

- 1. Pack IC per Packing Method with BQM 5000 unit per Reel
- 2. Drop 9 times by height 4 ft. (Per Figure 1)
- 3. Visual Inspection and see damaged or abnormal



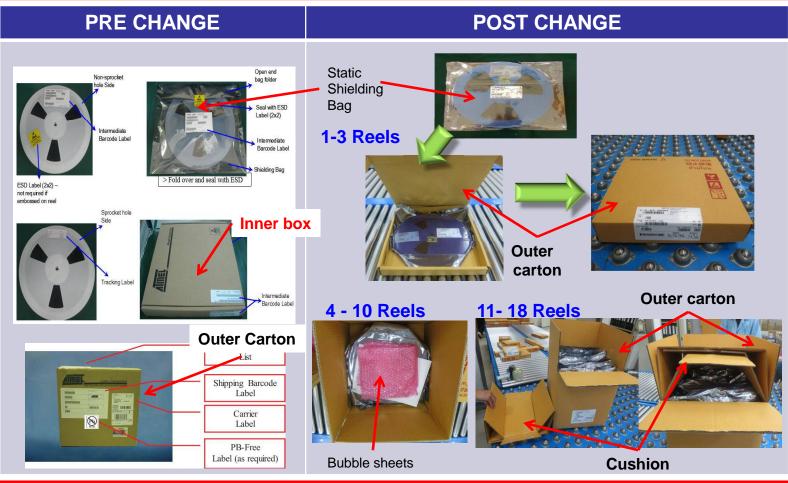




FOI Visual 100% result: No Any Damage on Tape and Reel, Not Found Seal off, Not found IC damage Box Condition: Found minor damaged at inner box



Non dry pack in 13 inch Reel (MSL – 1)



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Affected Catalog Part Numbers(CPN)

AT30TS00-MAH-T

AT30TS01-MAA5M-T

AT30TS01-MAA5M-T-452

AT30TSE002A-MAH-T

AT30TSE002B-MAHGS-T

AT30TSE002B-MAHSB-T

AT30TSE002B-MAH-T

AT30TSE002B-MAH-T-053

AT30TSE002B-MAH-T-452

AT30TSE002B-MAH-T-975

AT30TSE004A-MA5M-T

AT30TSE004A-MAA5AK-T

AT30TSE004A-MAA5AK-T-053

AT30TSE004A-MAA5M-T

AT30TSE004A-MAA5M-T-053

AT30TSE004A-MAA5M-T-452